

249558US2 DIV

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF: :

Atsuhiko SATO et al :

SERIAL NO: NEW DIVISIONAL APPLN. :

FILED: HEREWITH :

FOR: MANUFACTURING METHOD OF SEMICONDUCTOR
DEVICE WITH FILLING INSULATING FILM INTO TRENCH

PRELIMINARY AMENDMENT

COMMISSIONER FOR PATENTS
ALEXANDRIA, VA 22313

SIR:

Prior to examination on the merits, please amend the above-identified divisional application as follows:

Amendment to the Specification begins on page 2.

Amendments to the Claims begin on page 3 of this paper.

Remarks/Arguments begin on page 6 of this paper.